

N-Channel Enhancement Mode MOSFET

TDM31522

DESCRIPTION

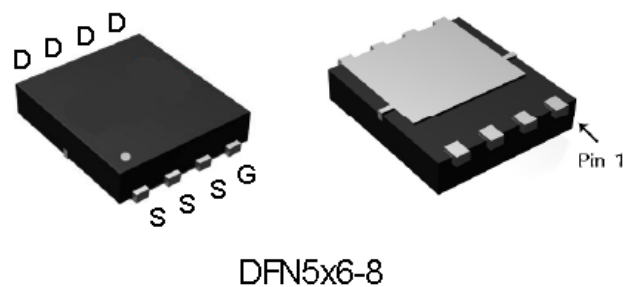
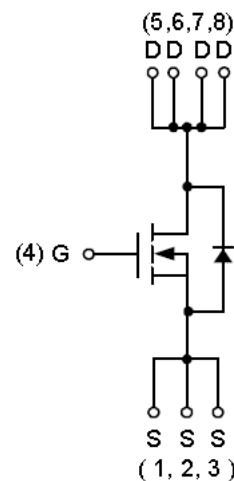
The TDM31522 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

GENERAL FEATURES

- RDS(ON) < 38mΩ @ VGS=10V
- Reliable and Rugged
- Lead free product is available
- DFN5X6-8 Package

Application

- PWM applications
- Load switch
- Power management



ABSOLUTE MAXIMUM RATINGS($T_A=25^{\circ}C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|--|--|-------|------|
| Drain-Source Voltage | V _{DS} | 150 | V |
| Gate-Source Voltage | V _{GS} | ±25 | V |
| Diode Continuous Forward Current | I _S (T _C =25°C) | 16 | A |
| Drain Current @ Continuous | I _D (T _C =25°C) | 32 | A |
| | I _D (T _C =100°C) | 20 | A |
| Drain Current @ Current-Pulsed (Note 1) | I _{DM} (T _C =25°C) | 96 | A |
| Maximum Power Dissipation | P _D (T _C =25°C) | 96 | W |
| | P _D (T _C =100°C) | 38 | W |
| Drain Current @ Continuous | I _D (T _A =25°C) | 7.4 | A |
| | I _D (T _A =70°C) | 5.9 | A |
| Maximum Power Dissipation (T _A =25°C) | P _D (T _A =25°C) | 5 | W |
| | P _D (T _A =70°C) | 3.2 | W |
| Avalanche Energy, Single pulse(L=0.5mH) | E _{AS} | 42 | mJ |

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THERMAL CHARACTERISTICS

| | | | |
|---|---------------------------------------|------------|-----------------------------|
| Thermal Resistance-Junction to Case | $R_{\theta JC}$ | 1.3 | $^{\circ}\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA} (t \leq 10s)$ | 25 | $^{\circ}\text{C}/\text{W}$ |
| | $R_{\theta JA} (\text{Steady State})$ | 60 | $^{\circ}\text{C}/\text{W}$ |
| Maximum Operating Junction Temperature | T_J | 150 | $^{\circ}\text{C}$ |
| Storage Temperature Range | T_{STG} | -55 To 150 | $^{\circ}\text{C}$ |

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

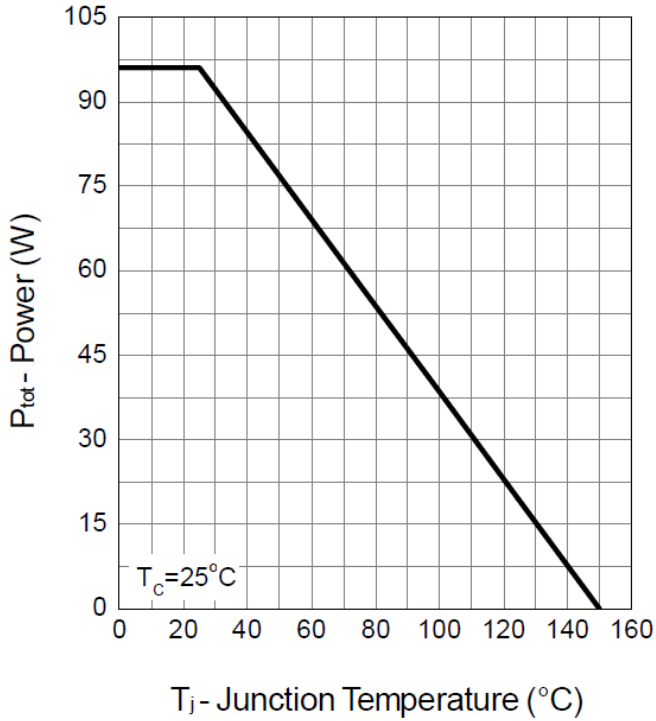
| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|-----|------|-----------|------------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 150 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=120V, V_{GS}=0V$ | - | - | 1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 25V, V_{DS}=0V$ | - | - | ± 100 | nA |
| ON CHARACTERISTICS (Note 2) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 2 | 3 | 4 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=16A$ | - | 32 | 38 | m Ω |
| DYNAMIC CHARACTERISTICS (Note 3) | | | | | | |
| Gate Resistance | R_G | $V_{DS}=0V, V_{GS}=0V, F=1.0\text{MHz}$ | - | 1.0 | - | Ω |
| Input Capacitance | C_{iss} | $V_{DS}=30V, V_{GS}=0V, F=1.0\text{MHz}$ | - | 2550 | 3320 | PF |
| Output Capacitance | C_{oss} | | - | 190 | - | PF |
| Reverse Transfer Capacitance | C_{rss} | | - | 50 | - | PF |
| SWITCHING CHARACTERISTICS (Note 3) | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DS}=30V, R_L=30\Omega, V_{GEN}=10V, R_G=6\Omega, I_D=1A$ | - | 23 | 42 | nS |
| Turn-on Rise Time | t_r | | - | 9 | 17 | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 42 | 76 | nS |
| Turn-Off Fall Time | t_f | | - | 19 | 35 | nS |
| Total Gate Charge | Q_g | $V_{DS}=75V, I_D=16A, V_{GS}=10V$ | - | 41 | 58 | nC |
| Gate-Source Charge | Q_{gs} | | - | 15 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 8 | - | nC |
| Body Diode Reverse Recovery Time | T_{rr} | $I_F=10A, di/dt=100A/\mu s$ | - | 90 | - | nS |
| Body Diode Reverse Recovery Charge | Q_{rr} | | - | 220 | - | nC |
| DRAIN-SOURCE DIODE CHARACTERISTICS | | | | | | |
| Diode Forward Voltage (Note 2) | V_{SD} | $V_{GS}=0V, I_S=8A$ | - | 0.8 | 1.3 | V |

NOTES:

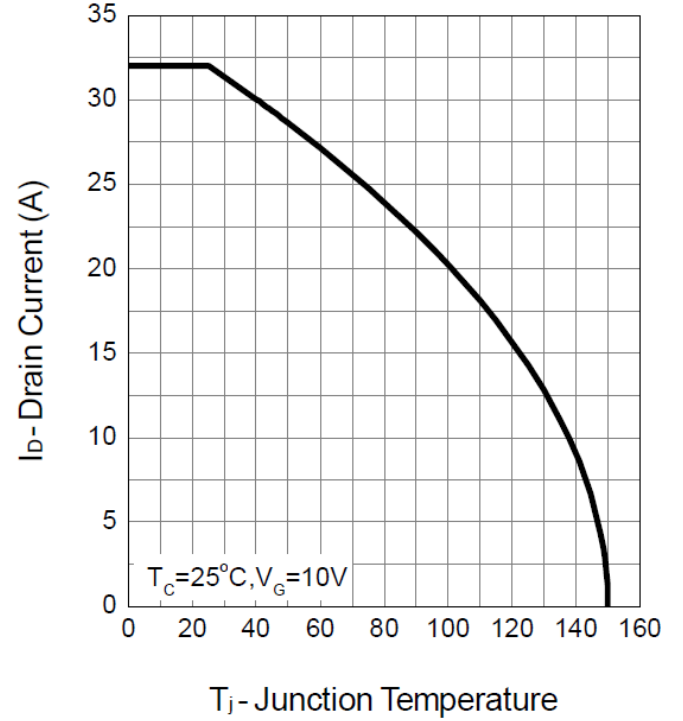
1. Pulse width limited by max. junction temperature.
2. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
3. Guaranteed by design, not subject to production testing

Typical Operating Characteristics

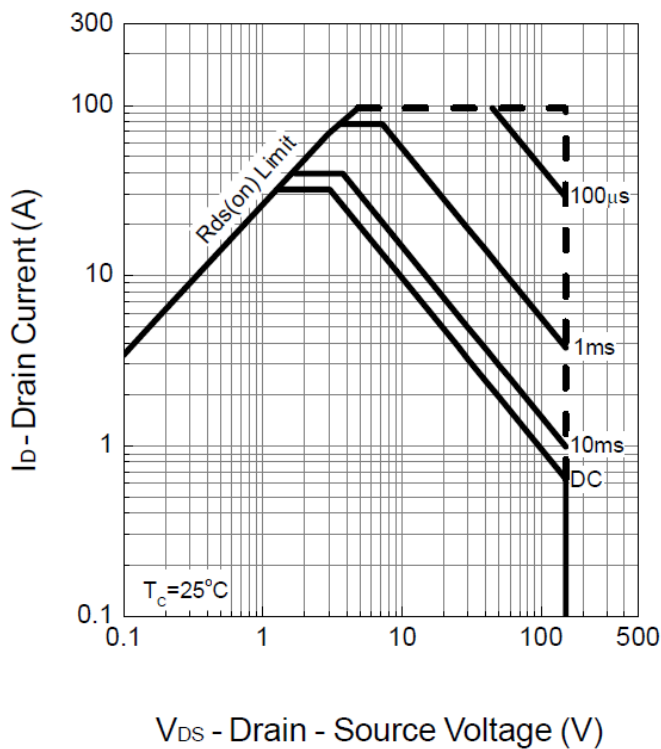
Power Dissipation



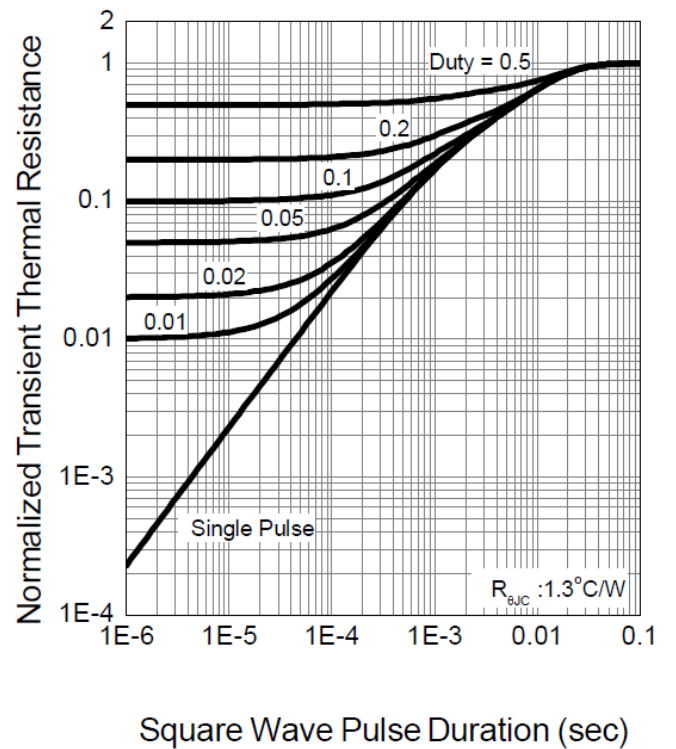
Drain Current



Safe Operation Area

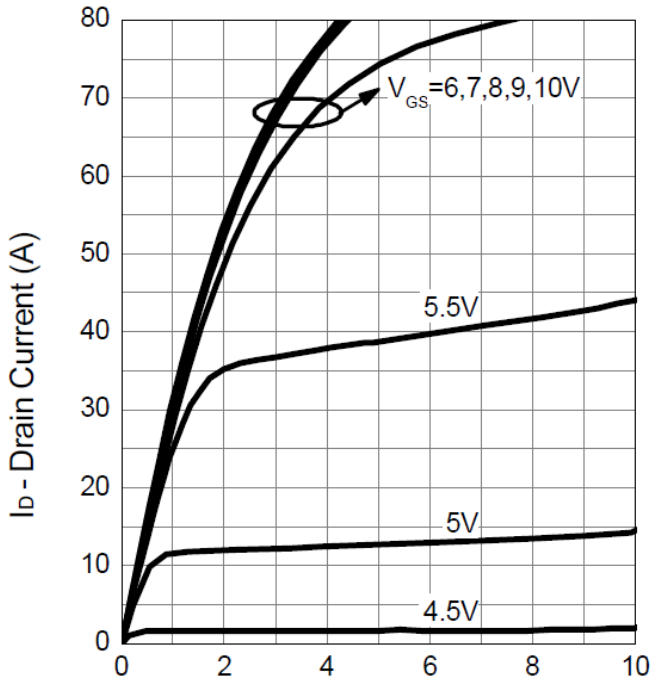


Thermal Transient Impedance



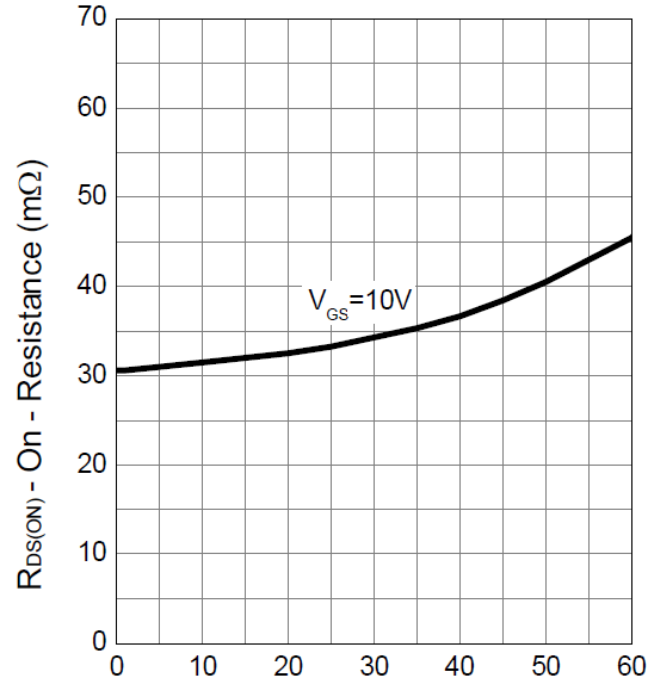
Typical Operating Characteristics (Cont.)

Output Characteristics



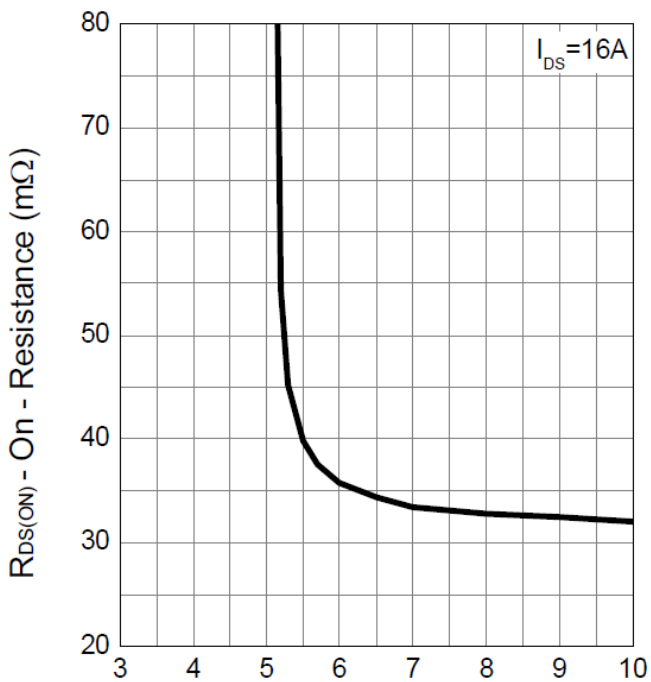
V_{DS} - Drain - Source Voltage (V)

Drain-Source On Resistance



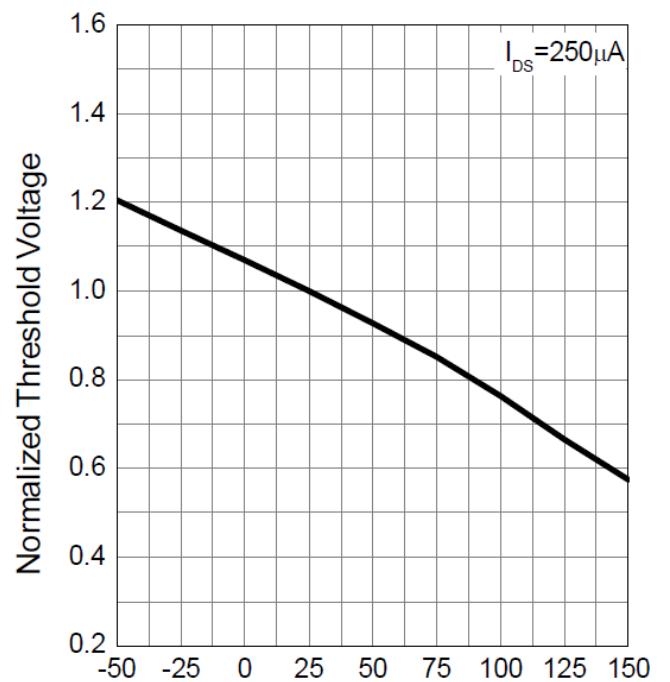
I_D - Drain Current (A)

Gate-Source On Resistance



V_{GS} - Gate - Source Voltage (V)

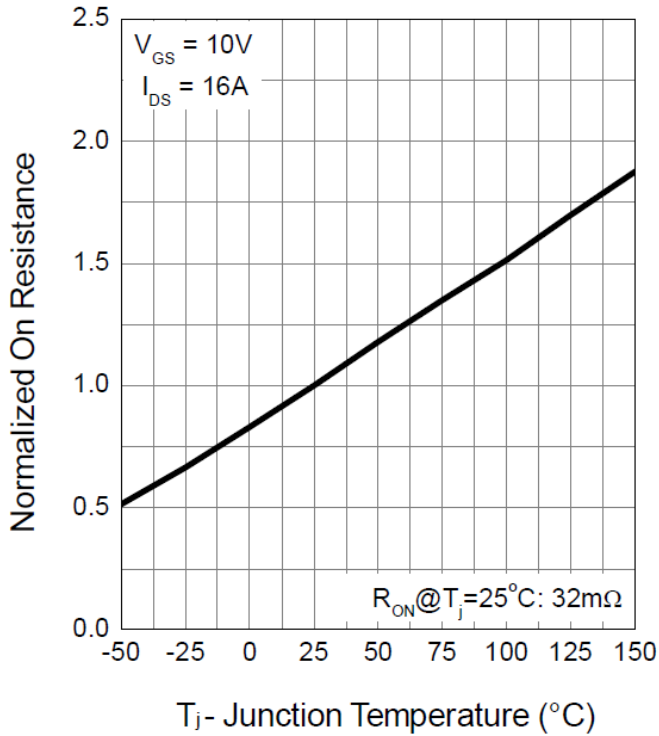
Gate Threshold Voltage



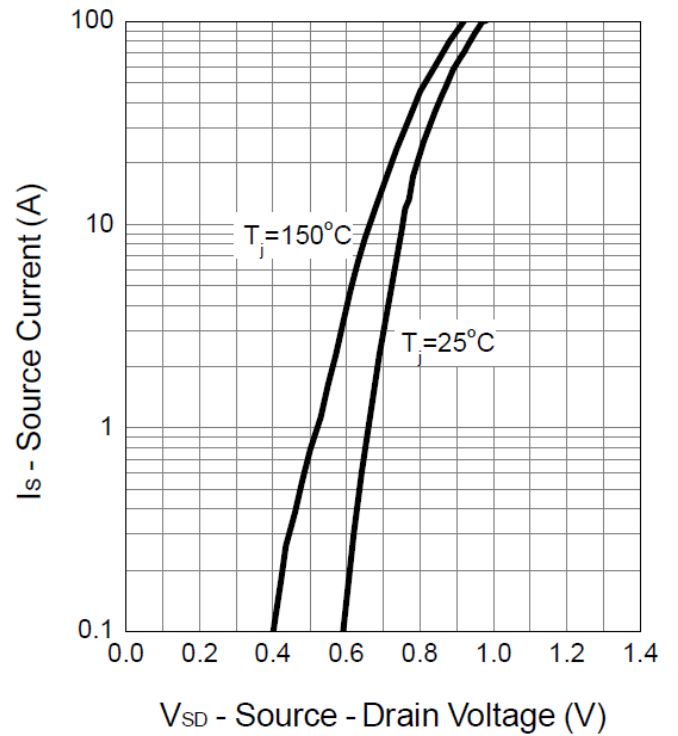
T_j - Junction Temperature ($^{\circ}C$)

Typical Operating Characteristics (Cont.)

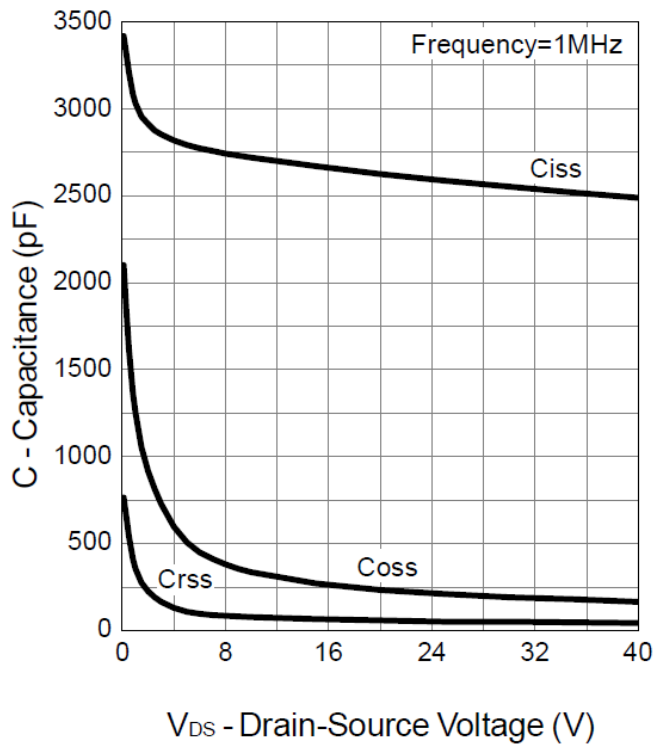
Drain-Source On Resistance



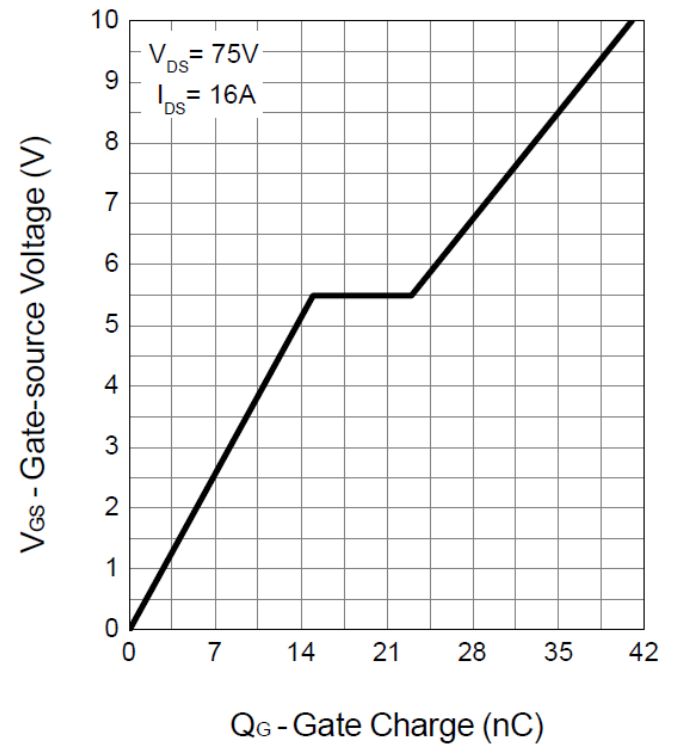
Source-Drain Diode Forward



Capacitance

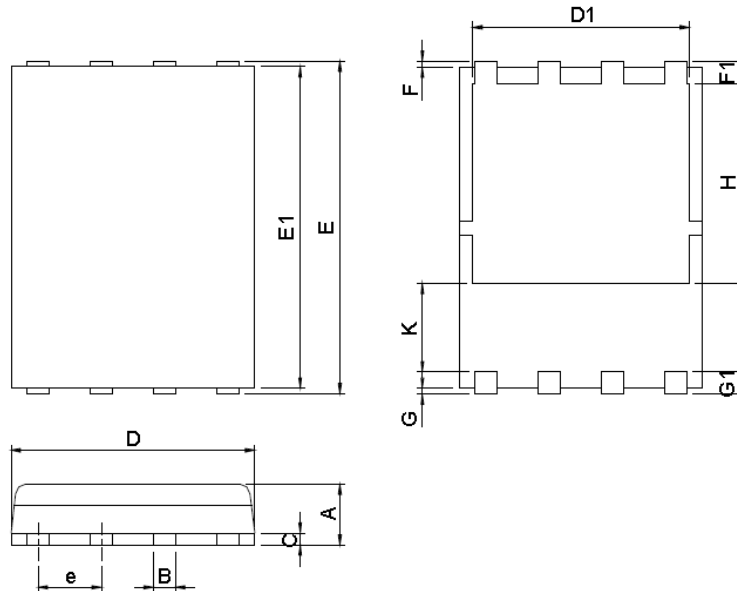


Gate Charge



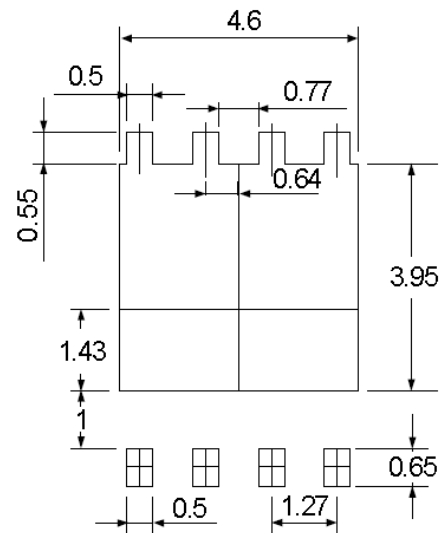
Package Information

DFN5*6-8 Package



| SYMBOL | DFN5x6-8 | | | |
|--------|-------------|------|-----------|-------|
| | MILLIMETERS | | INCHES | |
| | MIN. | MAX. | MIN. | MAX. |
| A | 0.90 | 1.20 | 0.035 | 0.047 |
| B | 0.3 | 0.51 | 0.012 | 0.020 |
| C | 0.19 | 0.25 | 0.007 | 0.010 |
| D | 4.80 | 5.30 | 0.189 | 0.209 |
| D1 | 4.00 | 4.40 | 0.157 | 0.173 |
| E | 5.90 | 6.20 | 0.232 | 0.244 |
| E1 | 5.50 | 5.80 | 0.217 | 0.228 |
| e | 1.27 BSC | | 0.050 BSC | |
| F | 0.05 | 0.30 | 0.002 | 0.012 |
| F1 | 0.35 | 0.75 | 0.014 | 0.030 |
| G | 0.05 | 0.30 | 0.002 | 0.012 |
| G1 | 0.35 | 0.75 | 0.014 | 0.030 |
| H | 3.34 | 3.9 | 0.131 | 0.154 |
| K | 0.762 | - | 0.03 | - |

RECOMMENDED LAND PATTERN



UNIT: mm

Note : 1.Dimension D, D1,D2 and E1 do not include mold flash or protrusions.
Mold flash or protrusions shall not exceed 10 mil.

Design Notes